


## Features

- RoHS compliant\*
- SMA package
- Surface mount
- Very low forward voltage drop

 This series is currently available but not recommended for new designs. The **Model CD214A-B2xR Series** is the recommended replacement.

## CD214A-B220 ~ B260 Schottky Barrier Rectifier Chip Diode

### General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers Schottky Rectifier Diodes for rectification applications, in compact chip package DO-214AC (SMA) size format, which offer PCB real estate savings and are considerably smaller than competitive parts. The Schottky Rectifier Diodes offer a forward current of 2 A with a choice of repetitive peak reverse voltage of 20 V up to 60 V.

Bourns® Chip Diodes conform to JEDEC standards, are easy to handle on standard pick and place equipment and their flat configuration minimizes roll away.

### Electrical Characteristics (@ T<sub>A</sub> = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD214A-						Unit
		B220	B230	B240	B240L	B250	B260	
Forward Voltage (Max.) (I <sub>f</sub> = 2 A)	V <sub>F</sub>	0.5	0.5	0.5	0.43	0.7	0.7	V
Typical Junction Capacitance**	C <sub>T</sub>	200						pF
Reverse Current (Max.) at Rated V <sub>R</sub> )	I <sub>R</sub>	0.5	0.5	0.5	2.0	0.5	0.5	mA

\*\* Measured at 1.0 MHz and applied reverse voltage of 4.0 VDC.

### Absolute Ratings (@ T<sub>A</sub> = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD214A-						Unit
		B220	B230	B240	B240L	B250	B260	
Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	20	30	40	40	50	60	V
Reverse Voltage	V <sub>R</sub>	20	30	40	40	50	60	V
Maximum RMS Voltage	V <sub>RMS</sub>	14	21	28	28	35	42	V
Avg. Forward Current	I <sub>O</sub>	2						A
Forward Current, Surge Peak (60 Hz, 1 cycle)	I <sub>surge</sub>	50	50	50	25	50	50	A
Typical Thermal Resistance***	R <sub>θJL</sub>	15	15	15	18	15	15	°C/W
Storage Temperature	T <sub>STG</sub>	-55 to +150						°C
Junction Temperature	T <sub>J</sub>	-55 to +125						°C

\*\*\* Thermal resistance junction to lead.

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### How to Order

Common Code	CD 214A - B 2 40 L LF
Chip Diode	
Package	214A = SMA/DO-214AC
Model	B = Schottky Barrier Series
Average Forward Current (I <sub>O</sub> ) Code	2 = 2 A (Code x 1000 mA = Average Forward Current)
Reverse Voltage (V <sub>R</sub> ) Code	30 = 30 V 40 = 40 V 60 = 60 V
Forward Voltage Suffix (Applies to -B240L only)	L = Low Forward Voltage V <sub>f</sub> (-B240L only) No Space in P/N = Not Low Forward Voltage
Terminations	LF = 100 % Sn (RoHS Compliant*)

\*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

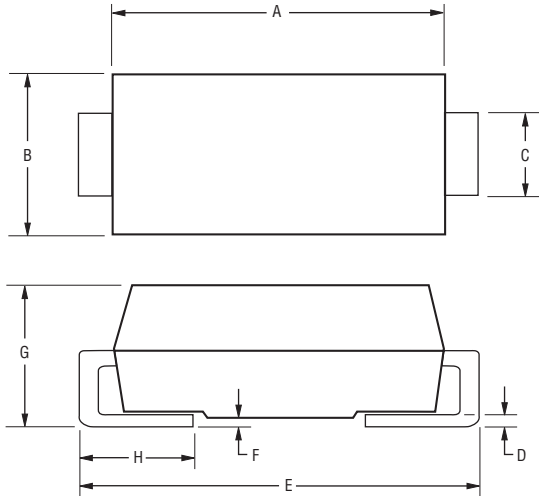
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.

# CD214A-B220 ~ B260 Schottky Barrier Rectifier Chip Diode



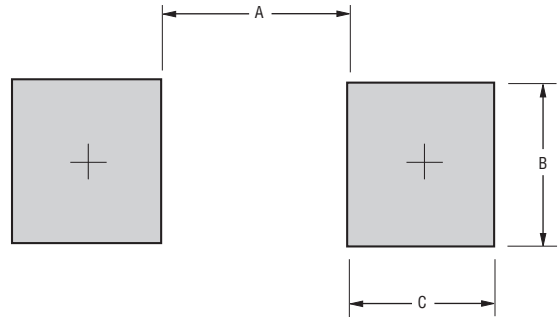
## Product Dimensions



Dimension	SMA (DO-214AC)
A	$\frac{4.06 - 4.57}{(0.160 - 0.180)}$
B	$\frac{2.29 - 2.92}{(0.090 - 0.115)}$
C	$\frac{1.27 - 1.63}{(0.050 - 0.064)}$
D	$\frac{0.15 - 0.31}{(0.006 - 0.110)}$
E	$\frac{4.83 - 5.59}{(0.190 - 0.220)}$
F	$\frac{0.05 - 0.20}{(0.002 - 0.008)}$
G	$\frac{2.01 - 2.62}{(0.080 - 0.103)}$
H	$\frac{0.76 - 1.52}{(0.030 - 0.060)}$

DIMENSIONS:  $\frac{\text{MM}}{\text{(INCHES)}}$

## Recommended Pad Layout



Dimension	SMA (DO-214AC)
A	$\frac{2.90}{(0.114)}$
B	$\frac{2.40}{(0.094)}$
C	$\frac{2.30}{(0.091)}$

DIMENSIONS:  $\frac{\text{MM}}{\text{(INCHES)}}$

## Physical Specifications

Case ..... Molded plastic  
 Polarity ..... Indicated by cathode band  
 Weight ..... 0.002 ounces / 0.064 grams

## Typical Part Marking

CD214A-B220 ..... **B** 220A  
 CD214A-B230 ..... **B** 230A  
 CD214A-B240 ..... **B** 240A  
 CD214A-B240L ..... **B** 240LA  
 CD214A-B250 ..... **B** 250A  
 CD214A-B260 ..... **B** 260A

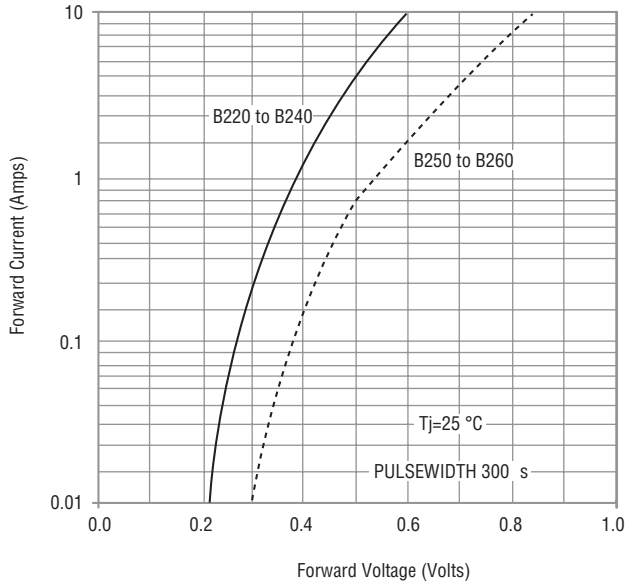
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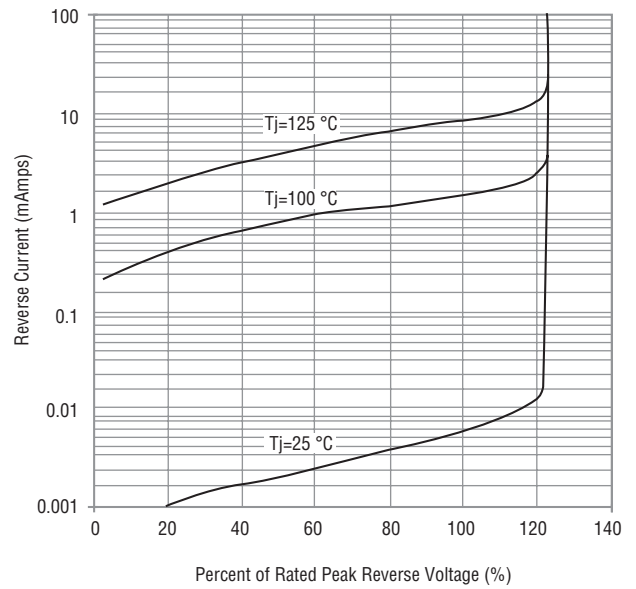


## Rating and Characteristic Curves: CD214A-B220, CD214A-B230, CD214A-B240, CD214A-B250 & CD214A-B260

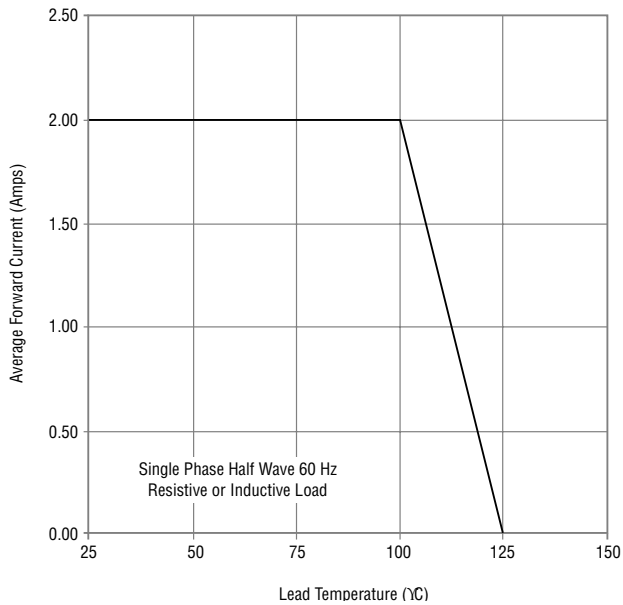
### Forward Characteristics



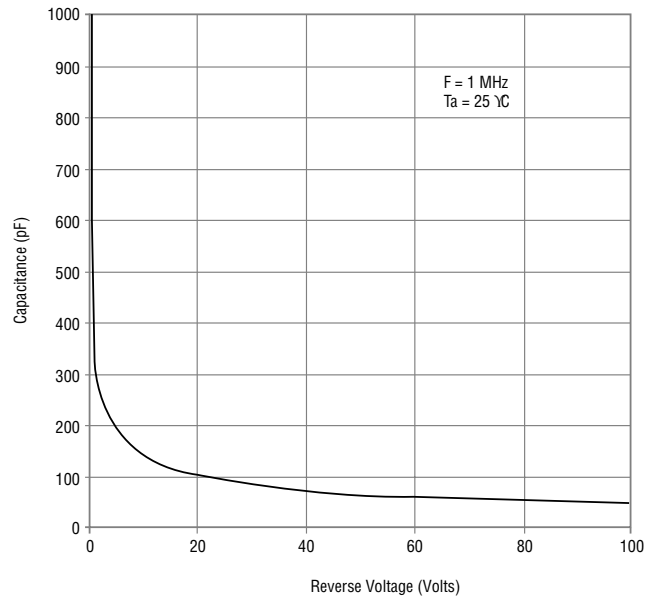
### Reverse Characteristics



### Derating Curve



### Capacitance Between Terminals



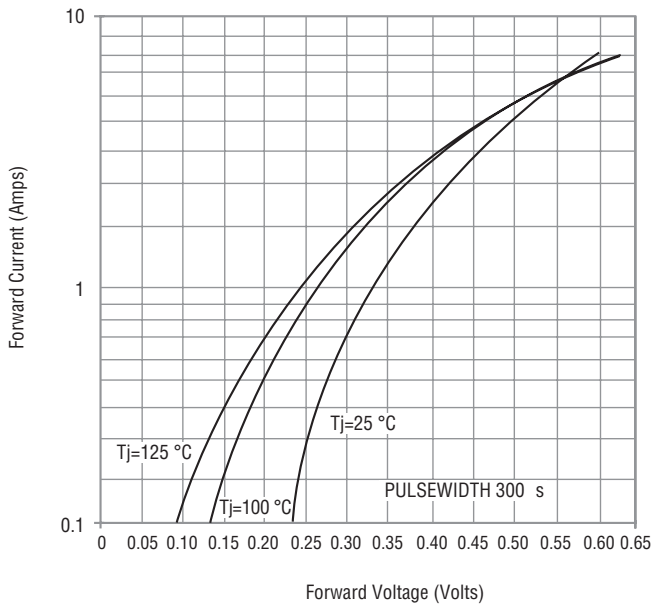
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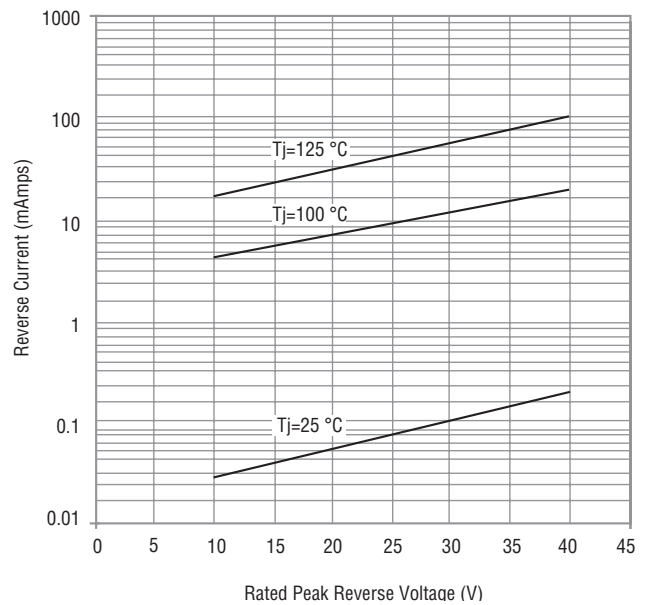


## Rating and Characteristic Curves: CD214A-B240L

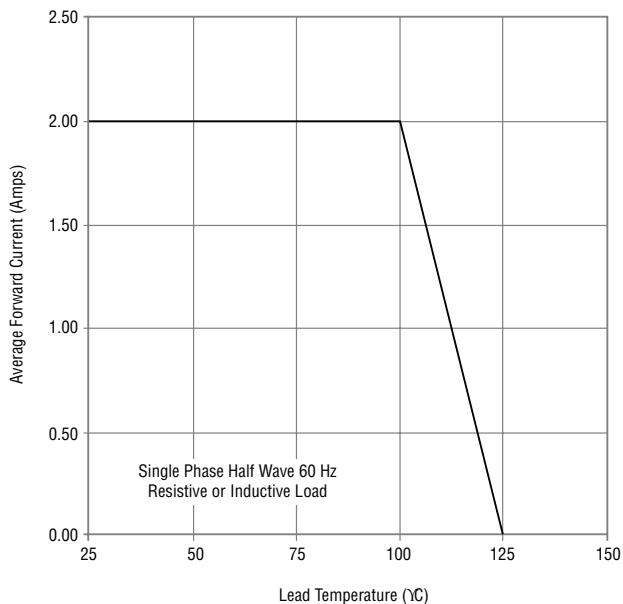
### Forward Characteristics



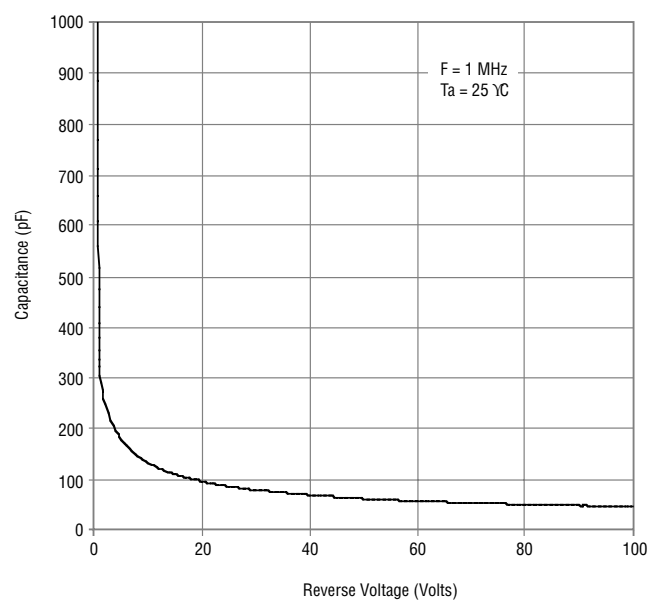
### Reverse Characteristics



### Derating Curve



### Capacitance Between Terminals



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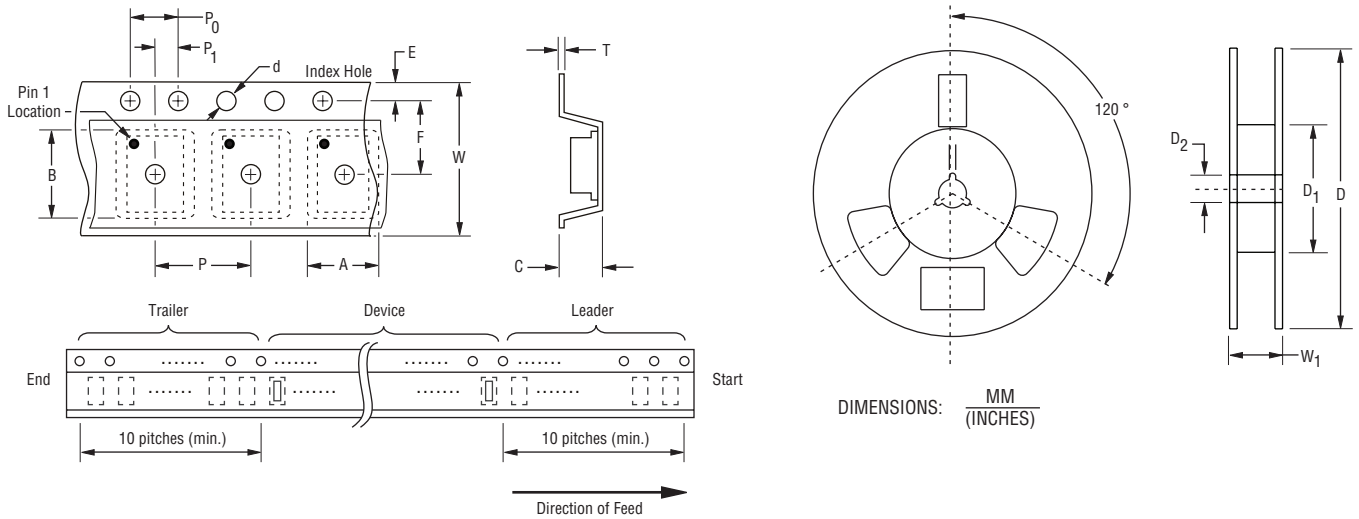
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# CD214A-B220 ~ B260 Schottky Barrier Rectifier Chip Diode

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## Packaging Information

The product is dispensed in tape and reel format (see diagram below).



Item	Symbol	SMA (DO-214AC)
Carrier Width	A	$\frac{2.90 \pm 0.10}{(0.114 \pm 0.004)}$
Carrier Length	B	$\frac{5.59 \pm 0.10}{(0.220 \pm 0.004)}$
Carrier Depth	C	$\frac{2.36 \pm 0.10}{(0.093 \pm 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 \pm 0.002)}$
Reel Outside Diameter	D	$\frac{3.30}{(12.992)}$
Reel Inner Diameter	D <sub>1</sub>	$\frac{50.0}{(1.969)}$ MIN.
Feed Hole Diameter	D <sub>2</sub>	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
Punch Hole Position	F	$\frac{5.50 \pm 0.05}{(0.217 \pm 0.002)}$
Punch Hole Pitch	P	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Sprocket Hole Pitch	P <sub>0</sub>	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Embossment Center	P <sub>1</sub>	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Overall Tape Thickness	T	$\frac{0.30 \pm 0.10}{(0.012 \pm 0.004)}$
Tape Width	W	$\frac{12.00 \pm 0.20}{(0.472 \pm 0.008)}$
Reel Width	W <sub>1</sub>	$\frac{18.4}{(0.724)}$ MAX.
Quantity per Reel	--	5,000

Devices are packed in accordance with EIA standard RS-481-A and specifications shown here.

REV. 01/18

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